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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET

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MOS FIELD EFFECT TRANSISTOR NP40N055ELE, NP40N055KLE NP40N055CLE, NP40N055DLE, NP40N055MLE, NP40N055NLE

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

<R> ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	MACKAGE		
NP40N055ELE-E1-AY Note1, 2			TO-263 (MP-25ZJ) typ. 1.4 g		
NP40N055ELE-E2-AY Note1, 2		Tana 800 n/raal			
NP40N055KLE-E1-AY Note1	Pure Sn (Tin)	Tape 800 p/reel			
NP40N055KLE-E2-AY Note1			TÖ-263 (MP-25ZK) typ. 1.5 g		
NP40N055CLE-S12-AZ Note1, 2	Sn-Ag-Cu		TO-220 (MP-25) typ. 1.9 g		
NP40N055DLE-S12-AY Note1, 2		Tube 50 p/tube	TO-262 (MP-25 Fin Cut) typ. 1.8 g		
NP40N055MLE-S18-AY Note1	Pure Sn (Tin)		TO-220 (MP-25K) typ. 1.9 g		
NP40N055NLE-S18-AY Note1		<u> </u>	TO-262 (MP-25SK) typ. 1.8 g		

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

C

2. Not for new design

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance $R_{DS(on)1} = 23 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 20 \text{ A})$

 $R_{DS(on)2} = 28 \text{ m}\Omega \text{ MAX.} (V_{GS} = 5.0 \text{ V}, \text{ ID} = 20 \text{ A})$

- $R_{DS(on)3} = 32 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, \text{ ID} = 20 \text{ A})$
- Low input capacitance
- Ciss = 1300 pF TYP.
- Built-in gate protection diode



(TO-262)



(TO-263)



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The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

JCL

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	VDSS	55	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	D(DC)	±40	А
Drain Current (pulse) ^{Note1}	D(pulse)	±100	А
Total Power Dissipation (T _A = 25°C)	Pτ	1.8	W
Total Power Dissipation (Tc = 25°C)	Pτ	66	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	–55 to +175	°C
Single Avalanche Current ^{Note2}	las	29/21/8	А
Single Avalanche Energy ^{Note2}	Eas	0.8/44/64	mJ

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = 28 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V (see Figure 4.)

THERMAL RESISTANCE

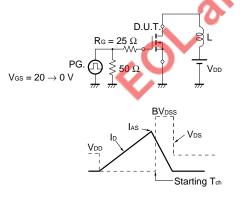
Rth(ch-C)	2.27	°C/W
Rth(ch-A)	83.3	°C/W
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	20	
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N		

Data Sheet D14093EJ7V0DS

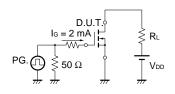
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 55 V, V _{GS} = 0 V			10	μA
Gate Leakage Current	lgss	V_{GS} = ±20 V, V_{DS} = 0 V			±10	μA
Gate to Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1.5	2.0	2.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 20 A	8	18		S
Drain to Source On-state Resistance	RDS(on)1	V _{GS} = 10 V, I _D = 20 A		18	23	mΩ
	RDS(on)2	V _{GS} = 5.0 V, I _D = 20 A		21	28	mΩ
	RDS(on)3	V _{GS} = 4.5 V, I _D = 20 A		24	32	mΩ
Input Capacitance	Ciss	V _{DS} = 25 V,		1300	1950	pF
Output Capacitance	Coss	V _{GS} = 0 V,		190	280	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		92	170	pF
Turn-on Delay Time	td(on)	V _{DD} = 28 V, I _D = 20 A,		14	32	ns
Rise Time	tr	V _{GS} = 10 V,		8.4	21	ns
Turn-off Delay Time	td(off)	R _G = 1 Ω		39	78	ns
Fall Time	tr	40		7.4	19	ns
Total Gate Charge	Q _{G1}	V _{DD} = 44 V, V _{GS} = 10 V, I _D = 40 A		27	41	nC
	Q _{G2}	Vdd = 44 V,		15	23	nC
Gate to Source Charge	QGS	Vgs = 5.0 V,		5		nC
Gate to Drain Charge	Qgd	lo = 40 A		8		nC
Body Diode Forward Voltage	VF(S-D)	IF = 40 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 40 A, VGs = 0 V,		40		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		50		nC

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

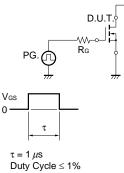
TEST CIRCUIT 1 AVALANCHE CAPABILITY

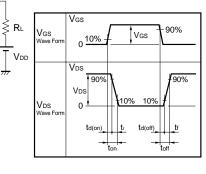


TEST CIRCUIT 3 GATE CHARGE

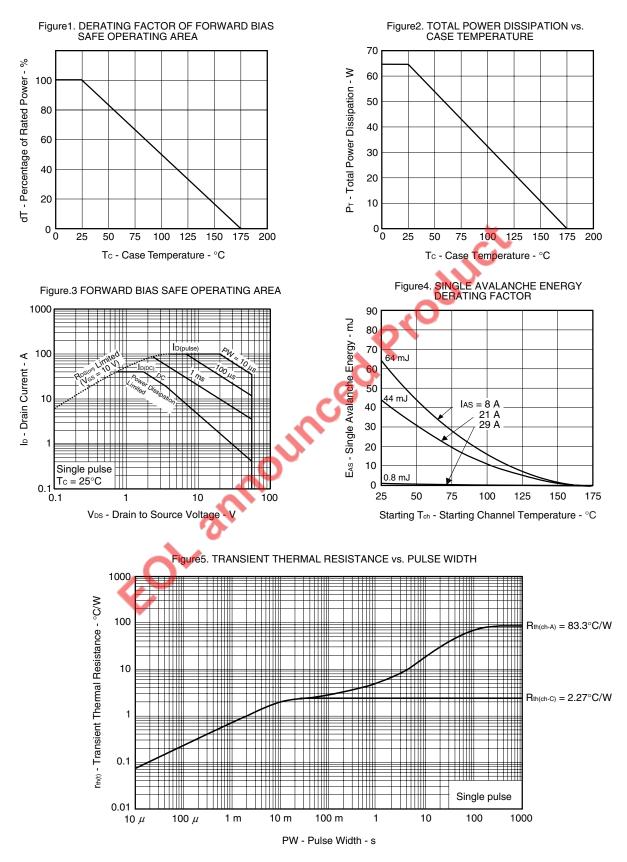


TEST CIRCUIT 2 SWITCHING TIME



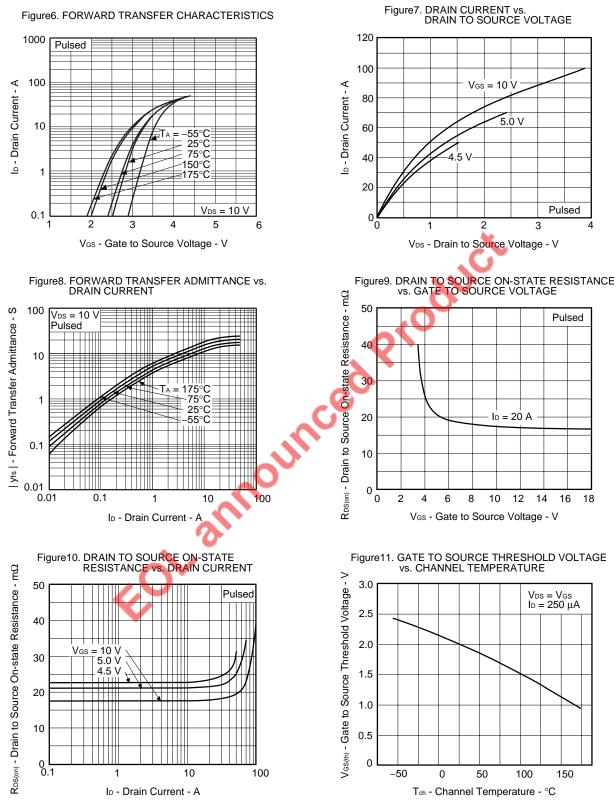


TYPICAL CHARACTERISTICS $(T_A = 25^{\circ}C)$

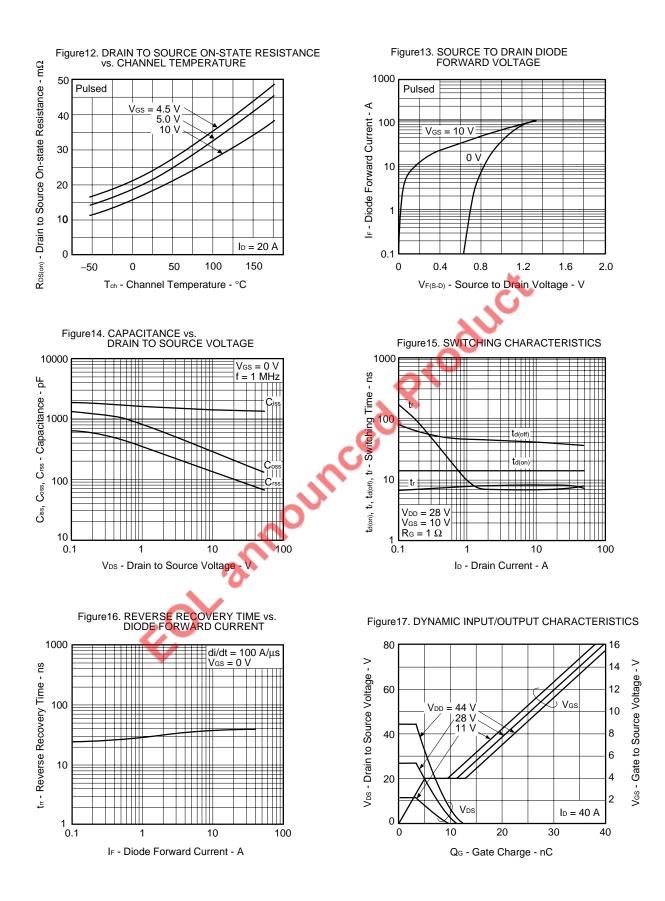


Data Sheet D14093EJ7V0DS

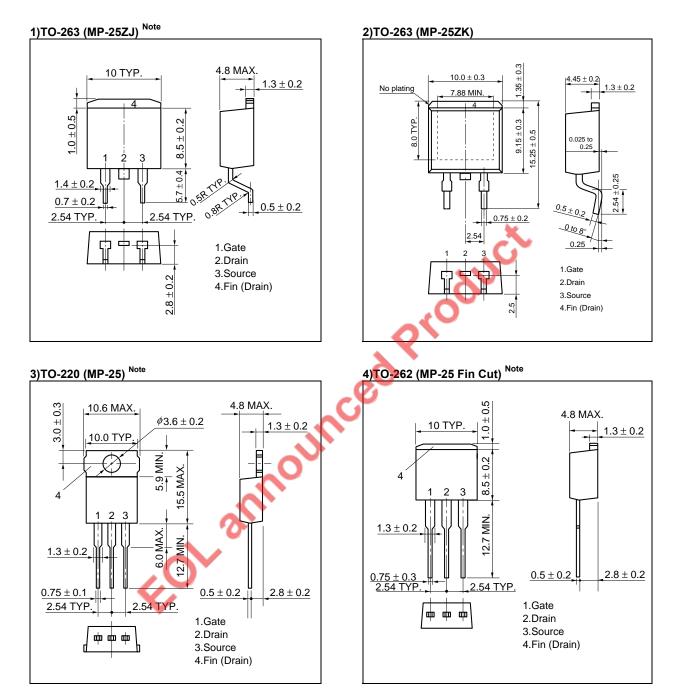
Figure6. FORWARD TRANSFER CHARACTERISTICS



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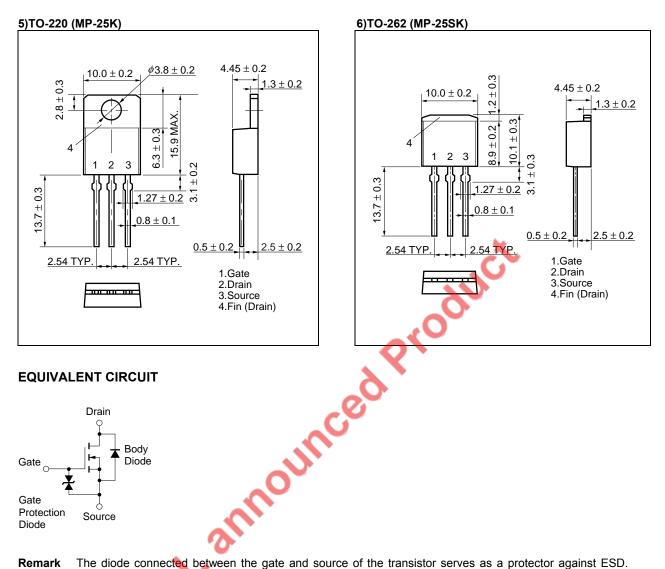


<R> PACKAGE DRAWINGS (Unit: mm)



Note Not for new design

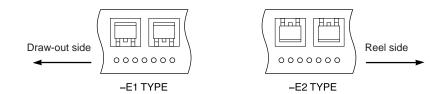




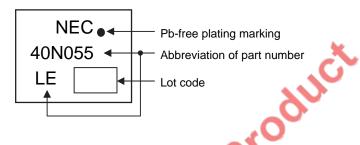
Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

<R> TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



<R> MARKING INFORMATION



<R> RECOMMENDED SOLDERING CONDITIONS

These products should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol	
Infrared reflow	Maximum temperature (Package's surface temperature): 260°C or below		
MP-25ZJ, MP-25ZK	Time at maximum temperature: 10 seconds or less		
	Time of temperature higher than 220°C: 60 seconds or less	IR60-00-3	
	Preheating time at 160 to 180°C: 60 to 120 seconds		
$\mathbf{\vee}$	Maximum number of reflow processes: 3 times		
	Maximum chlorine content of rosin flux (percentage mass): 0.2% or less		
Wave soldering	Maximum temperature (Solder temperature): 260°C or below		
MP-25, MP-25K, MP-25SK,	Time: 10 seconds or less	THDWS	
MP-25 Fin Cut	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		
Partial heating	Maximum temperature (Pin temperature): 350°C or below		
MP-25ZJ, MP-25ZK,	Time (per side of the device): 3 seconds or less	P350	
MP-25K, MP-25SK	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		
Partial heating	Maximum temperature (Pin temperature): 300°C or below		
MP-25, MP-25 Fin Cut	Time (per side of the device): 3 seconds or less	P300	
	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		

Caution Do not use different soldering methods together (except for partial heating).

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